## 8-Lead Plastic Small Outline (SN) - Narrow, 3.90 mm (. 150 In.) Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging


TOP VIEW


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| Units |  | MILLIMETERS |  |  |
| :---: | :---: | :---: | :---: | :---: |
| Dimension Limits |  | MIN | NOM | MAX |
| Number of Pins | N | 8 |  |  |
| Pitch | e | 1.27 BSC |  |  |
| Overall Height | A | - | - | 1.75 |
| Molded Package Thickness | A2 | 1.25 | - | - |
| Standoff § | A1 | 0.10 | - | 0.25 |
| Overall Width | E | 6.00 BSC |  |  |
| Molded Package Width | E1 | 3.90 BSC |  |  |
| Overall Length | D | 4.90 BSC |  |  |
| Chamfer (Optional) | h | 0.25 | - | 0.50 |
| Foot Length | L | 0.40 | - | 1.27 |
| Footprint | L1 | 1.04 REF |  |  |
| Foot Angle | $\varphi$ | $0^{\circ}$ | - | $8^{\circ}$ |
| Lead Thickness | c | 0.17 | - | 0.25 |
| Lead Width | b | 0.31 | - | 0.51 |
| Mold Draft Angle Top | $\alpha$ | $5^{\circ}$ | - | $15^{\circ}$ |
| Mold Draft Angle Bottom | $\beta$ | $5^{\circ}$ | - | $15^{\circ}$ |

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.
5. Datums A \& B to be determined at Datum $H$.

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## RECOMMENDED LAND PATTERN

|  | Units | MILLIMETERS |  |  |  |  |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dimension Limits |  |  |  |  |  |  | MIN |  | NOM | MAX |
| Contact Pitch | E | 1.27 BSC |  |  |  |  |  |  |  |  |
| Contact Pad Spacing | C |  | 5.40 |  |  |  |  |  |  |  |
| Contact Pad Width (X8) | X 1 |  |  | 0.60 |  |  |  |  |  |  |
| Contact Pad Length (X8) | Y 1 |  |  | 1.55 |  |  |  |  |  |  |

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

